

#### **Product Change Notification / RMES-14WQGP950**

Date:

03-May-2023

#### **Product Category:**

Power Management - PWM Controllers

#### **PCN Type:**

Manufacturing Change

#### **Notification Subject:**

CCB 5301 Final Notice: Qualification of MTAI as an additional final test site for MIC210xYML device family available in 16L VQFN (3x3x1.00mm) package.

#### **Affected CPNs:**

RMES-14WQGP950\_Affected\_CPN\_05032023.pdf RMES-14WQGP950\_Affected\_CPN\_05032023.csv

#### **Notification Text:**

**PCN Status:**Final Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of MTAI as an additional final test site for MIC210xYML device family available in 16L VQFN (3x3x1.00mm) package.

#### **Pre and Post Change Summary:**

	Pre Change	Post	Change
Final Test Site	Unisem (M) Berhad	Unisem (M)	Microchip
	Perak, Malaysia	Berhad Perak,	Technology Thailand

	(UNIS)	Malaysia	(HQ)			
	(01413)	(UNIS)	(MTAI)			
Packing Media	Tape and Reel	Tape and Reel	Tape and Reel			
Base Quantity Multiple (BQM)	5000	5000	5000			
Pin 1 Orientation	Q1	Q1	Q1			
Carrier Tape		nanges. e comparison				
Cover Tape		minor dimensional ched pre and post chang	Ŭ			
	White	White	Dark Blue			
Reel Color	With minor dimensional changes. See attached pre and post change comparison					
Moisture Barrier Bag	No dimensional changes. See attached pre and post change comparison See attached pre and post change comparison					
Packing Method						

#### Impacts to Data Sheet:None

#### Change ImpactNone

**Reason for Change:**To improve manufacturability and on-time delivery performance by qualifying MTAI as an additional final test site.

#### **Change Implementation Status:**In Progress

Estimated First Ship Date: August 25, 2023 (date code: 2334)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	Se	September 2022			^		Ma	ay 20	23		^		Aug	ust 2	2023		
Workweek	3 6	3 7	3 8	3 9	4 0		1 8	1 9	2	2 1	2 2		3 1	3 2	3	3 4	3 5
Initial PCN Issue Date			Χ														

Qual Report Availability				Х						
Final PCN Issue Date				Χ						
Estimated Implementation Date									Х	

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:** September 15, 2022: Issued initial notification.

May 03, 2023: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on August 25, 2023.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

#### **Attachments:**

PCN\_RMES-14WQGP950\_Qual Report.pdf

PCN\_RMES-14WQGP950\_Pre and Post Change Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.



### QUALIFICATION REPORT SUMMARY RELIABILITY LABORATORY

PCN #: RMES-14WQGP950

Date: April 19, 2023

Qualification of MTAI as an additional final test site for MIC210xYML device family available in 16L VQFN (3x3x1.00mm) package.



Purpose Qualification of MTAI as an additional final test site for MIC210xYML device

family available in 16L VQFN (3x3x1.00mm) package.

CCB No. 5301

Test / Evaluation	Test Condition / Parameters	Result
Correlation Plan	<ul> <li>33 correlation units of MIC2104YML-TR to be tested at UNIS and send to MTAI for parametric correlation of ATE measured data sheet parameters.</li> </ul>	PASSED
Correlation Plan	<ul> <li>3,000 untested units from each package size for yield and bin- to-bin comparison (UNIS to MTAI).</li> </ul>	PASSED
	<ul> <li>Test flow: Final Test Room 100% -&gt; QA Sample Room.</li> </ul>	PASSED

RMES-14WQGP950 - CCB 5301 Final Notice: Qualification of MTAI as an additional final test site for MIC210xYML device family available in 16L VQFN (3x3x1.00mm) package.

Affected Catalog Part Numbers (CPN)

MIC2101YML-TR

MIC2102YML-TR

MIC2103YML-TR

MIC2104YML-TR

Date: Tuesday, May 02, 2023

### **CCB # 5301**

# Pre and Post change comparison PCN #: RMES-14WQGP950



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## Pre and Post Change Summary - Base Quantity Multiple (BQM) per reel

UNIS	MTAI
Units per reel: 5000	Units per reel: 5000

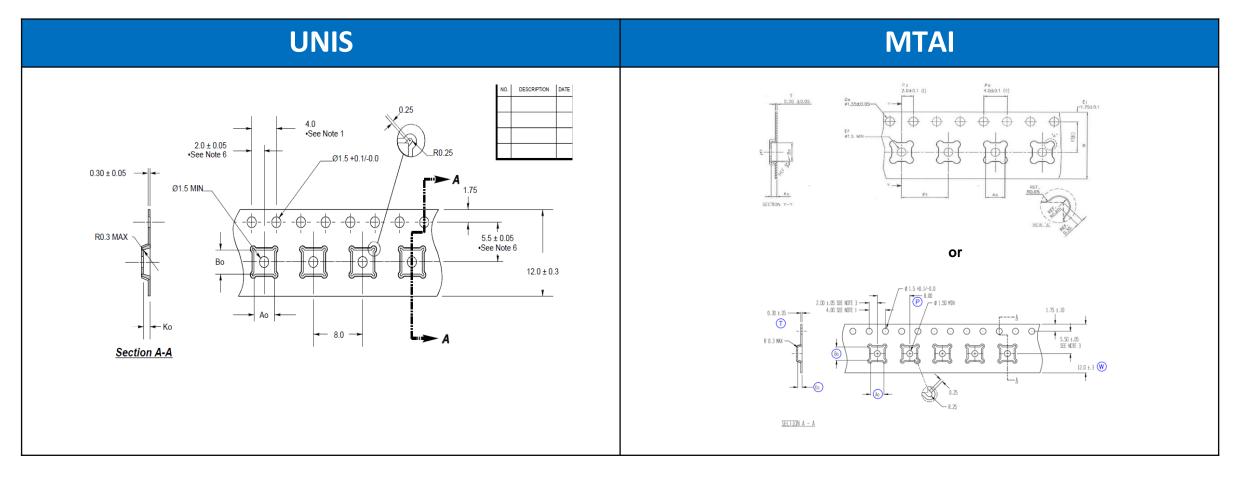


### **Pre and Post Change Summary – Pin 1 Orientation**

UNIS	MTAI
Quadrant 1	Quadrant 1



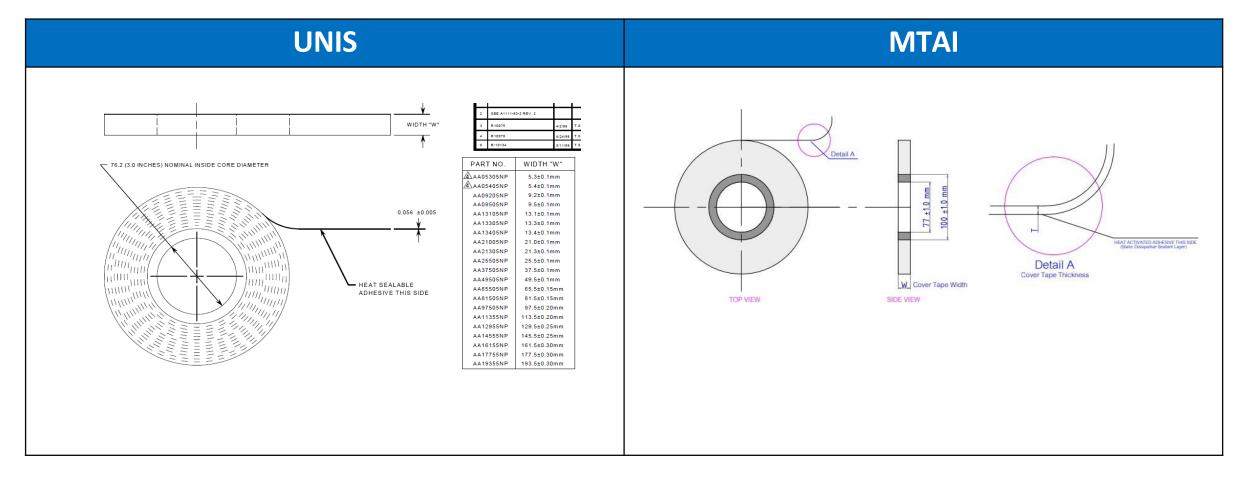
### **Pre and Post Change Summary - Carrier Tape**



Plant	W (mm.) ±0.3 or Specific	P (mm.) ±0.1 or Specific	A <sub>0</sub> ±0.1 or Specific	B <sub>0</sub> ±0.1 or Specific	K₀ ±0.1 or Specific
UNIS	12mm +0.3	8.00mm	3.30mm	3.30mm	1.10mm
MTAI	12mm +0.3	8.00mm	3.30mm	3.30mm	1.10mm or 1.00mm



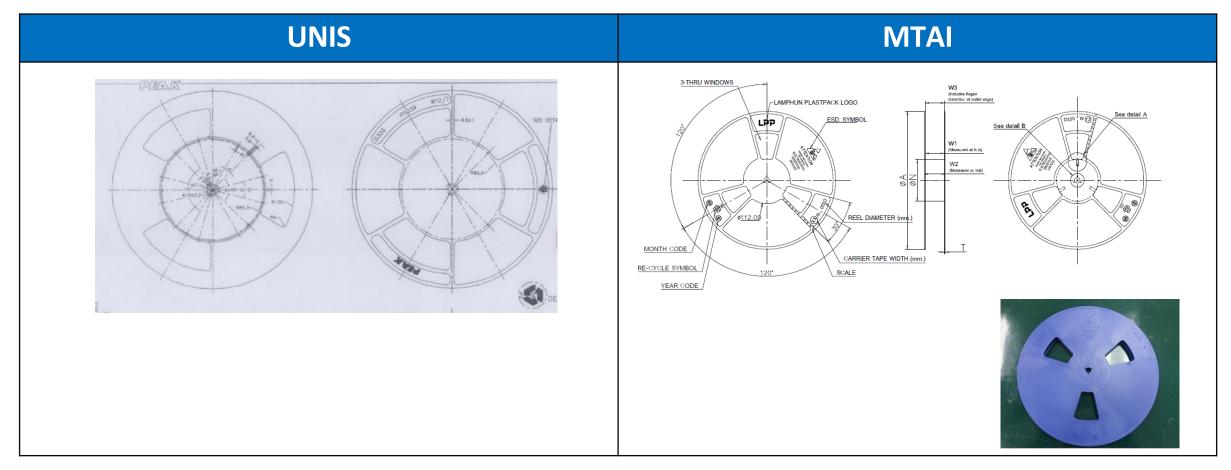
### **Pre and Post Change Summary - Cover Tape**



Plant	Cover Tape Width	Thickness	Color	Sealing mythology
UNIS	9.2mm	0.056mm	Clear	Heat Seal
MTAI	9.05+0.05/-0.15mm	0.050 ±0.010mm	Clear	Heat Seal



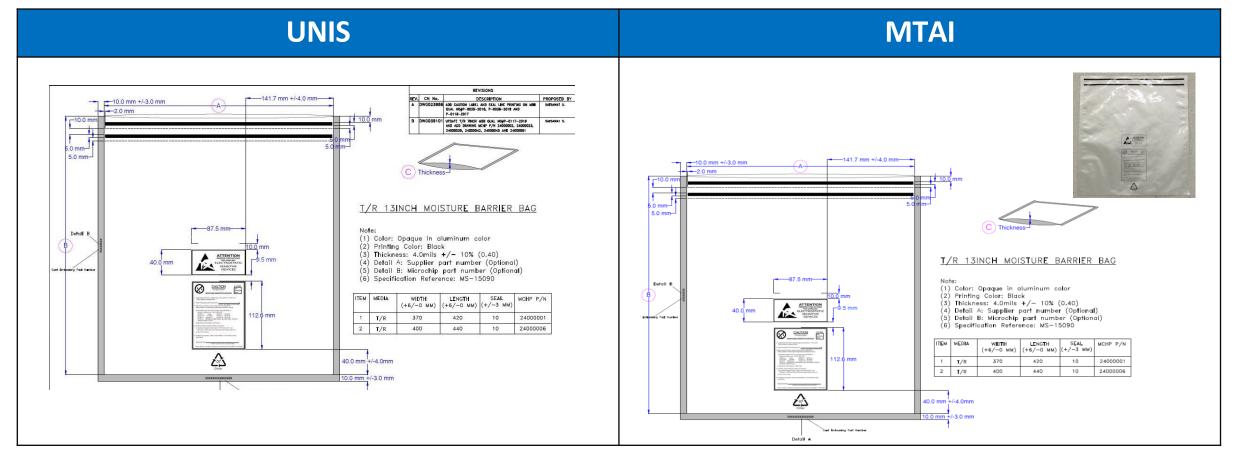
### **Pre and Post Change Summary - Plastic Reel**



Plant	Reel diameter Reel Hub Size (mm)		Reel Width Max (mm)	Reel Color
UNIS	330 +4.0/-0.25	177 ±2.0	18.40	White
MTAI	330 +/- 2.0	100 ±2.0	18.40	Dark Blue



### **Pre and Post Change Summary – Moisture Barrier Bag**



Plant	Plant Length (Inch)		Thickness (Mils)	
UNIS	16.53	14.56	4	
MTAI	16.53	14.56	4	



## **Pre and Post Change Summary – Packing Method**

